Formation of Banded Microstructure in V-4Cr-4Ti

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Banded Microstructures in V-4Cr-4Ti Alloys

- Phenomena observed in U.S. Heats and NIFS-Heat-1
 - lower interstitial content of NIFS-Heat-1 may have minor effect
- Focus on factors that affect Ti(OCN) formation
 - thermomechanical processing temperature
 - depends on solvus temperature for Ti(OCN)
 - interstitial concentration
 - solute segregationeffects

Formation of Banded Grain Structure

Extruded at 1130°-1150°C



TMP and Annealed 1100°C/2h



- Anisotropic microstructure develops during hot extrusion
 - dynamic recovery and recrystallized processes result in regions consisting of fine equiaxed and large elongated grains
 - no primary Ti(OCN) visible (LM)
- Non-uniform grain size and precipitate distribution develops during thermomechanical processing (TMP) and final recrystallization anneal

Recent Focus is on Segregation of Solute Atoms

Isochronal annealing from RT to 1200°C (1hr at either 50°C or 100°C increments - 14 total)



- Evidence suggests that Ti segregates during solidification in GTA weld fusion zone
 - -globular Ti(OCN) forms preferentially in Ti-rich regions during the isochronal annealings
- Also, from microprobe analysis of ingots prepared in RF
 composition modulations in Ti; λ = ~55μm (M.M. Potapenko et al. 1999)

Current View on Formation of Banded Microstructure

(plate fabricated from the U.S. 500kg Heat of V-4Cr-4Ti)

- Ingot
 - Ti segregation during solidification

Hot extrusion at 1130°C to 1150°C

- inhomogeneities in deformation rate and temperature influence dynamic recovery and recrystallization processes
- primary Ti(OCN) will likely be distributed non-homogeneously
 (1) localized regions with large undercooling
 - (2) regions of high dislocation densities

Sequence of warm rolling (400°C) and annealing (1050°C) steps

- deformation structure influenced by Ti(OCN) distribution during rolling
- recrystallization and further precipitation occur during annealing
- non-homogeneities in Ti(OCN) distribution leads to non-uniform grain growth, resulting in the *banded microstructure*